NBB-312

CASCADABLE BROADBAND GaAs MMIC AMPLIFIER DC TO 12 GHz

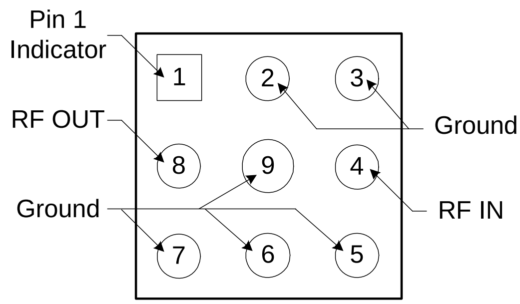
Package: MPGA, Bowtie, 3 x 3, Ceramic

Features

- Reliable, Low-Cost HBT Design
- 12.5 dB Gain
- High P1dB of +15.8 dBm at 6 GHz
- Single Power Supply Operation
- 50Ω I/O Matched for High Frequency Use

Applications

- Narrow and Broadband Commercial and Military Radio Designs
- Linear and Saturated Amplifiers
- Gain Stage or Driver Amplifiers for MW Radio/Optical Designs (PTP/PMP/LMDS/UNII/VSAT /WiFi/Cellular/DWDM)



Functional Block Diagram

Product Description

The NBB-312 cascadable broadband InGaP/GaAs MMIC amplifier is a low-cost, high-performance solution for general purpose RF and microwave amplification needs. This 50Ω gain block is based on a reliable HBT proprietary MMIC design, providing unsurpassed performance for small-signal applications. Designed with an external bias resistor, the NBB-312 provides flexibility and stability. The NBB-312 is packaged in a low-cost, surface-mount ceramic package, providing ease of assembly for high-volume tape-and-reel requirements. It is available in either 1,000 or 3,000 piece-per-reel quantities. Connectorized evaluation board designs optimized for high frequency are also available for characterization purposes.

Ordering Information

NBB-312	Cascadable Broadband GaAs MMIC Amplifier DC to 12 GHz
NBB-312-T1	Tape and Reel, 1000 Pieces
NBB-312-E	Fully Assembled Evaluation Board
NBB-X-K1	Extended Frequency InGaP Amp Designer's Tool Kit

Optimum Technology Matching® Applied

☐ GaAs HBT	☐ SiGe BiCMOS	☐ GaAs pHEMT	☐ GaN HEMT
☐ GaAs MESFET	☐ Si BiCMOS	☐ Si CMOS	☐ BiFET HBT
☑ InGaP HBT	☐ SiGe HBT	☐ Si BJT	☐ LDMOS

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Absolute Maximum Ratings

Parameter	Rating	Unit
RF Input Power	+20	dBm
Power Dissipation	350	mW
Device Current	70	mA
Channel Temperature	150	°C
Operating Temperature	-45 to +85	°C
Storage Temperature	-65 to +150	°C

Exceeding any one or a combination of these limits may cause permanent damage.

Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RFMD Green: RoHS compliant per EU Directive 2002/95/EC, halogen free per IEC 61249-2-21, < 1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Overall					V_D=+5V, I_{CC}=50mA, Z_0=50Ω, T_A=+25°C
Small Signal Power Gain, S21	12.5	12.9		dB	f=0.1GHz to 1.0GHz
	12.0	12.9		dB	f=1.0GHz to 4.0GHz
	11.4	11.7		dB	f=4.0GHz to 8.0GHz
	9.0	9.7		dB	f=8.0GHz to 12.0GHz
Gain Flatness, GF		+0.6		dB	f=0.1GHz to 8.0GHz
Input VSWR		1.2:1			f=0.1GHz to 7.0GHz
		1.65:1			f=7.0GHz to 10.0GHz
		2.0:1			f=10.0GHz to 12.0GHz
Output VSWR		1.5:1			f=0.1GHz to 12.0GHz
Bandwidth, BW		11.0		GHz	BW3 (3dB)
Output Power at -1dB Compression, P1dB		14.9		dBm	f=2.0GHz
		15.8		dBm	f=6.0GHz
		15.0		dBm	f=8.0GHz
		12.0		dBm	f=12.0GHz
Noise Figure, NF		4.9		dB	f=3.0GHz
Third Order Intercept, IP3		+24.0		dBm	f=2.0GHz
Reverse Isolation, S12		-15.6		dB	f=0.1GHz to 12.0GHz
Device Voltage, V_D	4.7	5.0	5.3	V	
Gain Temperature Coefficient, $\delta G_T/\delta T$		-0.0015		dB/°C	
MTTF versus Temperature at I_{CC}=50mA					
Case Temperature		85		°C	
Junction Temperature		123		°C	
MTTF		>1,000,000		hours	
Thermal Resistance					
θ_{JC}		152		°C/W	$\frac{J_T - T_{CASE}}{V_D \cdot I_{CC}} = \theta_{JC}(°C/Watt)$

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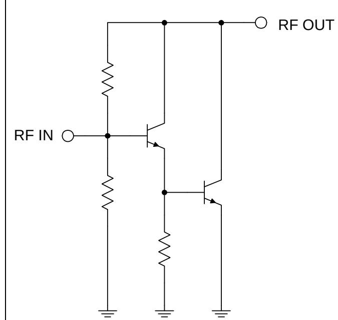
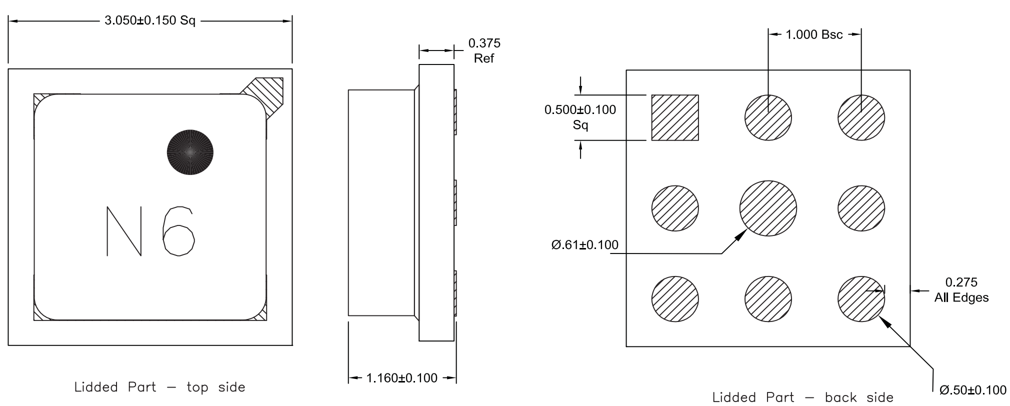
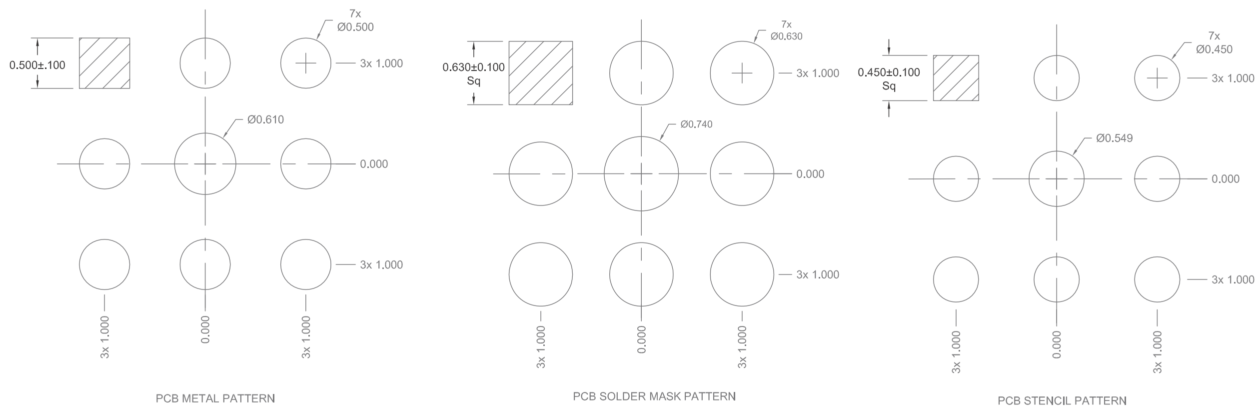
Pin	Function	Description	Interface Schematic
1	GND	Ground connection. For best performance, keep traces physically short and connect immediately to ground plane.	
2	GND	Same as pin 1.	
3	GND	Same as pin 1.	
4	RF IN	RF input pin. This pin is NOT internally DC blocked. A DC blocking capacitor, suitable for the frequency of operation, should be used in most applications. DC coupling of the input is not allowed, because this will override the internal feedback loop and cause temperature instability.	
5	GND	Same as pin 1.	
6	GND	Same as pin 1.	
7	GND	Same as pin 1.	
8	RF OUT	RF output and bias pin. Biasing is accomplished with an external series resistor and choke inductor to V_{CC}. The resistor is selected to set the DC current into this pin to a desired level. The resistor value is determined by the following equation: $R = \frac{(V_{CC} - V_{DEVICE})}{I_{CC}}$ Care should also be taken in the resistor selection to ensure that the current into the part never exceeds maximum datasheet operating current over the planned operating temperature. This means that a resistor between the supply and this pin is always required, even if a supply near 8.0V is available, to provide DC feedback to prevent thermal runaway. Alternatively, a constant current supply circuit may be implemented. Because DC is present on this pin, a DC blocking capacitor, suitable for the frequency of operation, should be used in most applications. The supply side of the bias network should also be well bypassed.	
9	GND	Same as pin 1.	

Package Drawing

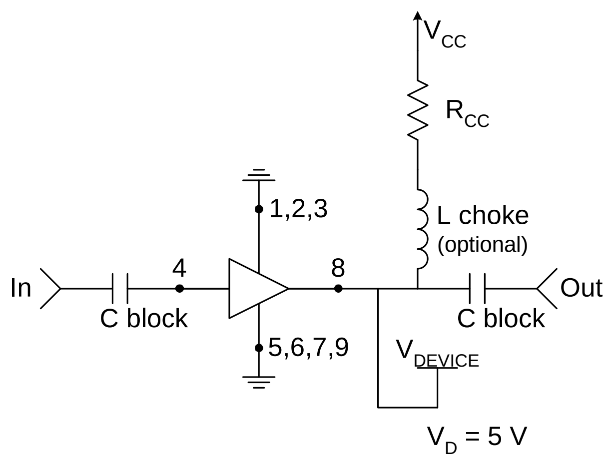


Recommended PCB Layout



Typical Bias Configuration

Application notes related to biasing circuit, device footprint, and thermal considerations are available on request.



Recommended Bias Resistor Values					
Supply Voltage, V_{CC} (V)	8	10	12	15	20
Bias Resistor, R_{CC} (Ω)	60	100	140	200	300

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Application Notes

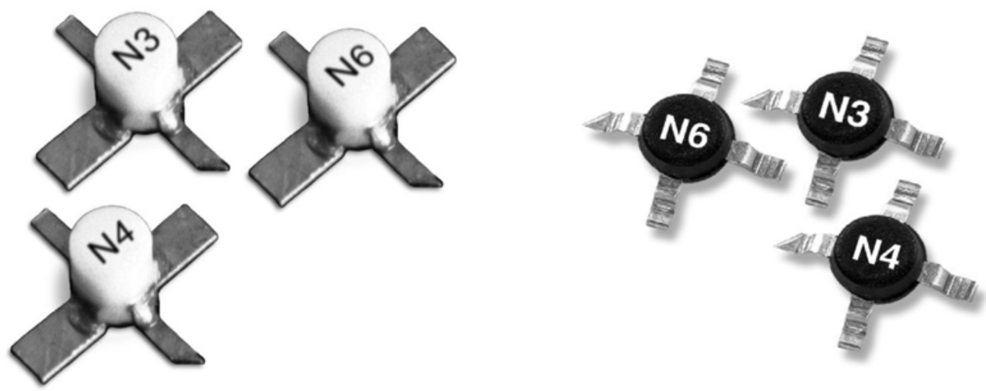
Bonding Temperature (Wedge or Ball)

It is recommended that the heater block temperature be set to 160°C±10°C.

Extended Frequency InGaP Amplifier Designer's Tool Kit
NBB-X-K1

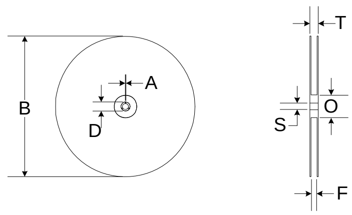
This tool kit was created to assist in the design-in of the RFMD NBB- and NLB-series InGap HBT gain block amplifiers. Each tool kit contains the following.

- 5 each NBB-300, NBB-310 and NBB-400 Ceramic Micro-X Amplifiers
- 5 each NLB-300, NLB-310 and NLB-400 Plastic Micro-X Amplifiers
- 2 Broadband Evaluation Boards and High Frequency SMA Connectors
- Broadband Bias Instructions and Specification Summary Index for ease of operation

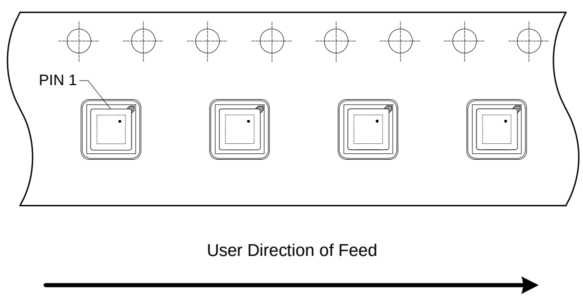


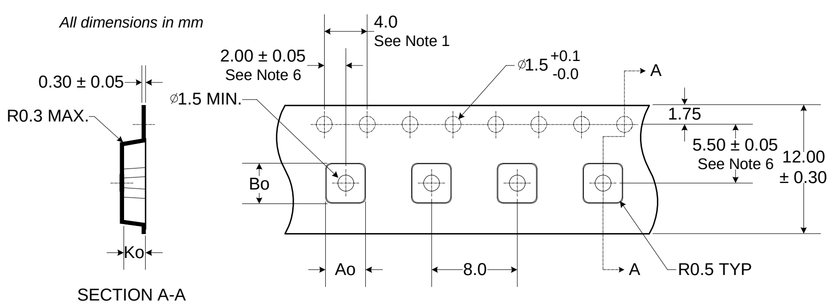
Tape and Reel Dimensions

All Dimensions in Millimeters



330 mm (13") REEL			Micro-X, MPGA	
	ITEMS	**SYMBOL**	**SIZE (mm)**	**SIZE (inches)**
FLANGE	Diameter	B	330 +0.25/-4.0	13.0 +0.079/-0.158
	Thickness	T	18.4 MAX	0.724 MAX
	Space Between Flange	F	12.4 +2.0	0.488 +0.08
HUB	Outer Diameter	O	102.0 REF	4.0 REF
	Spindle Hole Diameter	S	13.0 +0.5/-0.2	0.512 +0.020/-0.008
	Key Slit Width	A	1.5 MIN	0.059 MIN
	Key Slit Diameter	D	20.2 MIN	0.795 MIN





NOTES:
1. 10 sprocket hole pitch cumulative tolerance ±0.2.
2. Camber not to exceed 1 mm in 100 mm.
3. Material: PS+C
4. Ao and Bo measured on a plane 0.3 mm above the bottom of the pocket.
5. Ko measured from a plane on the inside bottom of the pocket to the surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

Ao = 3.6 MM
Bo = 3.6 MM
Ko = 1.7 MM

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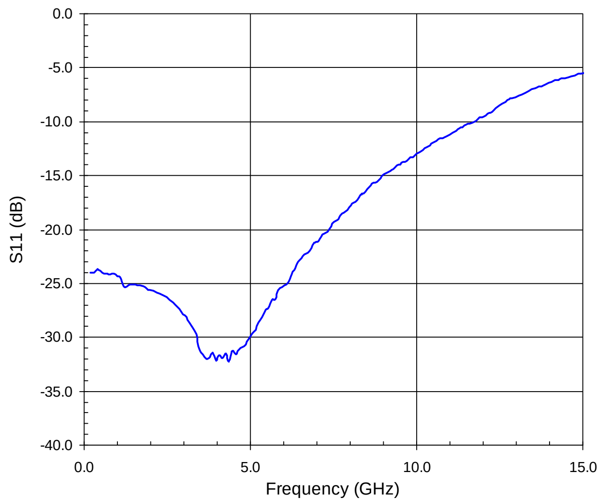
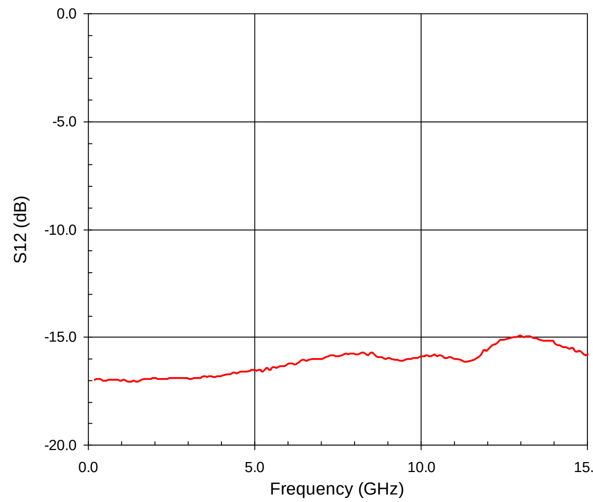
Note: The s-parameter gain results shown below include device performance as well as evaluation board and connector loss variations. The insertion losses of the evaluation board and connectors are as follows:

1GHz to 4GHz=-0.06dB
5GHz to 9GHz=-0.22dB
10GHz to 14GHz=-0.50dB
15GHz to 20GHz=-1.08dB

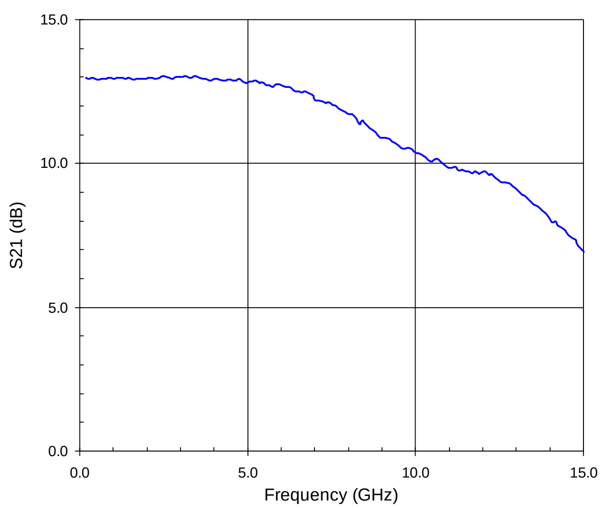
S11 versus Frequency at +25°C



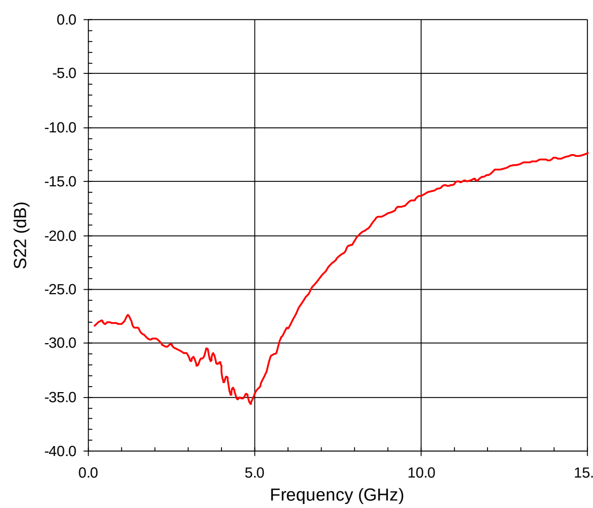
S12 versus Frequency at +25°C



S21 versus Frequency at +25°C



S22 versus Frequency at +25°C



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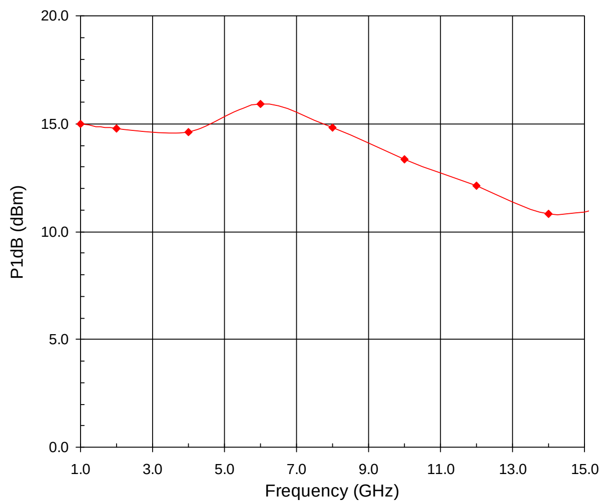
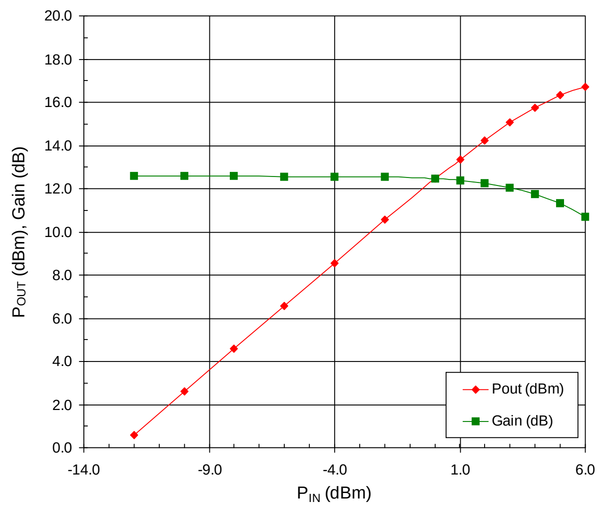
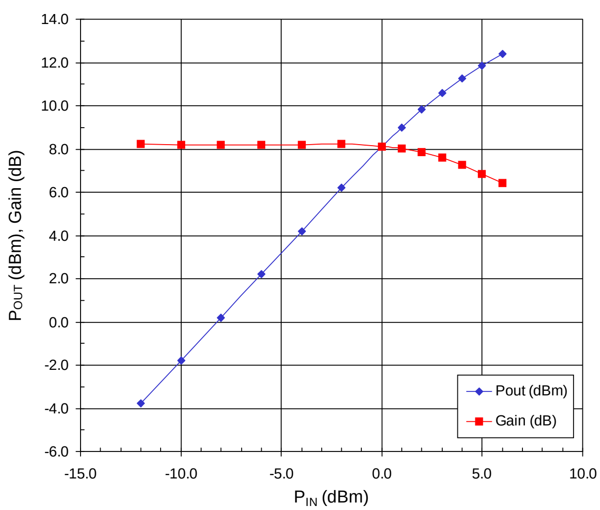
P1dB versus Frequency at 25°C



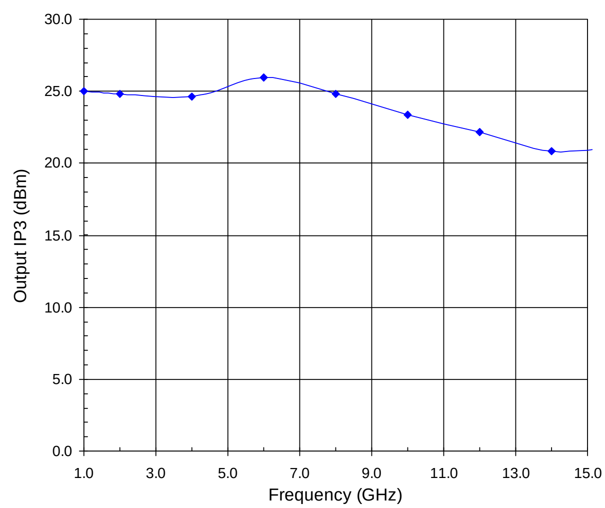
P_{OUT}/Gain versus P_{IN} at 6 GHz



P_{OUT}/Gain versus P_{IN} at 14 GHz



Third Order Intercept versus Frequency at 25°C



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RoHS* Banned Material Content

RoHS Compliant:	Yes
Package total weight in grams (g):	0.028
Compliance Date Code:	N/A
Bill of Materials Revision:	-
Pb Free Category:	e4

Bill of Materials	Parts Per Million (PPM)					
	Pb	Cd	Hg	Cr VI	PBB	PBDE
Die	0	0	0	0	0	0
Molding Compound	0	0	0	0	0	0
Lead Frame	0	0	0	0	0	0
Die Attach Epoxy	0	0	0	0	0	0
Wire	0	0	0	0	0	0
Solder Plating	0	0	0	0	0	0

This RoHS banned material content declaration was prepared solely on information, including analytical data, provided to RFMD by its suppliers, and applies to the Bill of Materials (BOM) revision noted above.

* DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment

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